



13mm (0.512 inch) One Digit NUMERIC FRAME DISPLAY

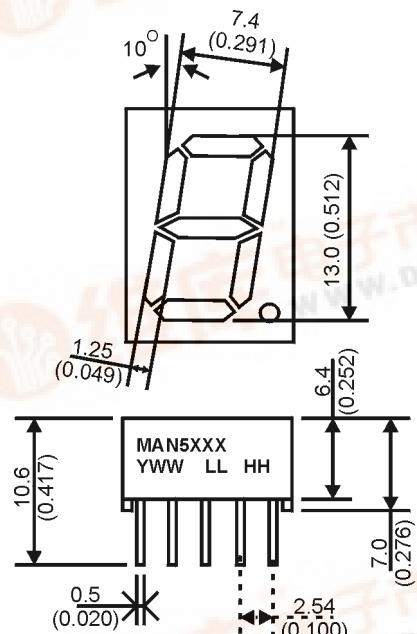
AllInGaP Red (632nm) MAN5H50, MAN5H60

AllInGaP Red (639nm) MAN5R50, MAN5R60

AllInGaP Yellow MAN5Y50, MAN5Y60

TR/QTS030100-001

PACKAGE DIMENSIONS



NOTES:

- Dimensions are in mm (inches)
- Tolerances are +/- 0.25 (0.010) unless otherwise stated.

FEATURES

- Bright Bold Segments
- Common Anode/Cathode
- Low Power Consumption
- Low Current Capability
- Neutral Segments
- Grey Face
- Epoxy Encapsulated Frame
- High Performance
- High Reliability

APPLICATIONS

- Appliances
- Automotive
- Instrumentation
- Process Control

MODELS AVAILABLE

Part Number	Colour	Description	Special
MAN5H50	AllInGaP 632nm	Single Digit, RHDP, Common Anode	Low Current Capability
MAN5H60	AllInGaP 632nm	Single Digit, RHDP, Common Cathode	Low Current Capability
MAN5R50	AllInGaP 639nm	Single Digit, RHDP, Common Anode	Low Current Capability
MAN5R60	AllInGaP 639nm	Single Digit, RHDP, Common Cathode	Low Current Capability
MAN5Y50	AllInGaP Yellow	Single Digit, RHDP, Common Anode	Low Current Capability
MAN5Y60	AllInGaP Yellow	Single Digit, RHDP, Common Cathode	Low Current Capability

(For other colour options, contact your local area Sales Manager)



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ABSOLUTE MAXIMUM RATINGS ⁽¹⁾ ($T_A = 25^\circ\text{C}$, unless otherwise specified)				
Part Number	MAN5H50	MAN5R50	MAN5Y50	
Parameter	MAN5H60	MAN5R60	MAN5Y60	Units
Continuous Forward Current (each segment)	25	25	25	mA
Peak Forward Current (F = 10KHz, D/F = 1/10)	100	100	100	mA
Power Dissipation (P_D)	60	60	60	mW
*Derate Linearly from 25°C	0.36	0.36	0.36	mW
Reverse Voltage per Die	5 Volts			
Operating and Storage Temperature Range	-40°C to +85°C			
Lead soldering time (1/16 inch from standoffs)	5 seconds @ 230°C			

ELECTRO-OPTICAL CHARACTERISTICS ⁽¹⁾ ($T_A = 25^\circ\text{C}$, unless otherwise specified)					
Part Number	MAN5H50	MAN5R50	MAN5Y50	Units	Test Condition
Parameter	MAN5H60	MAN5R60	MAN5Y60		
Luminous intensity⁽²⁾ (I_V)					
Minimum (Standard Current)	6000	4000	8000	ucd	I _F = 10mA
Typical (Standard Current)	7800	5800	12800	ucd	I _F = 10mA
Minimum (Low Current)	510	510	510	ucd	I _F = 2mA
Typical (Low Current)	1000	1000	1000	ucd	I _F = 2mA
Forward Voltage (V_F)					
Typical (Standard Current)	2.05	2.05	2.05	Volts	I _F = 20mA
Maximum (Standard Current)	2.40	2.40	2.40	Volts	I _F = 20mA
Typical (Low Current)	1.80	1.80	1.80	Volts	I _F = 2mA
Maximum (Low Current)	2.20	2.20	2.20	Volts	I _F = 2mA
Peak Wavelength	632	639	591	nm	I _F = 10mA
Dominant Wavelength	624	631	585	nm	I _F = 10mA
Spectral Line 1/2 Width	20	20	20	nm	I _F = 10mA
Reverse B⁽³⁾.Voltage (V_R)	5	5	5	Volts	I _R = 100uA

NOTES:

(1) Data per individual LED element

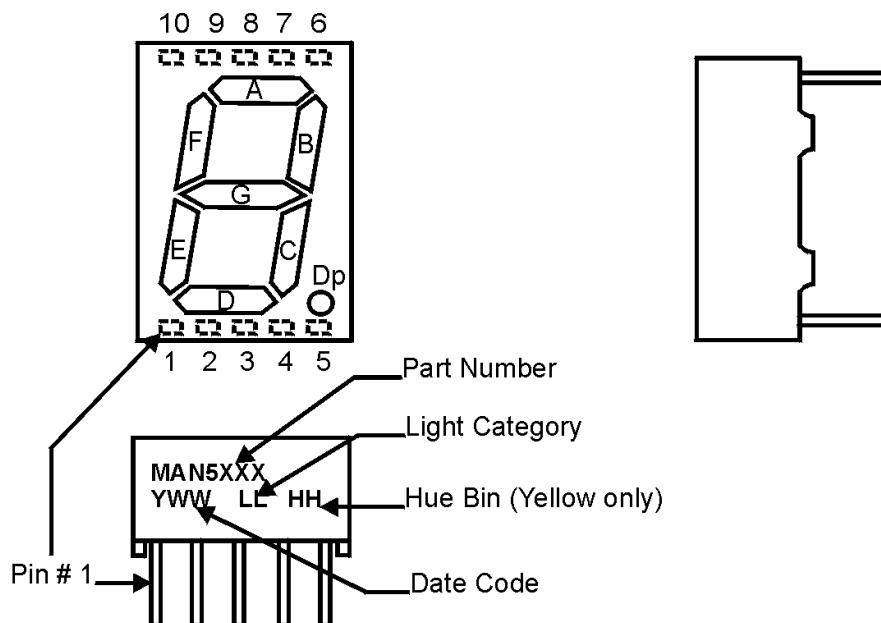
(2) Luminous intensity (ucd) = average light output per segment

(3) B = breakdown

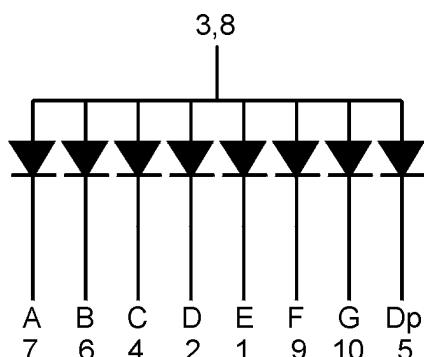


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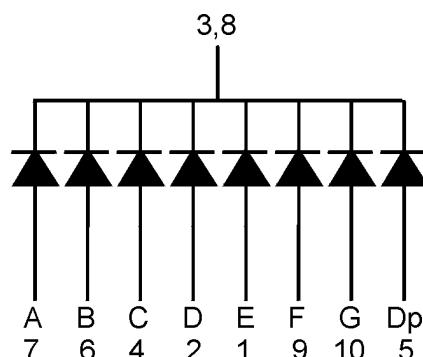
PIN ORIENTATION, SEGMENT IDENTIFICATION, AND PRODUCT MARKING



SCHEMATICS



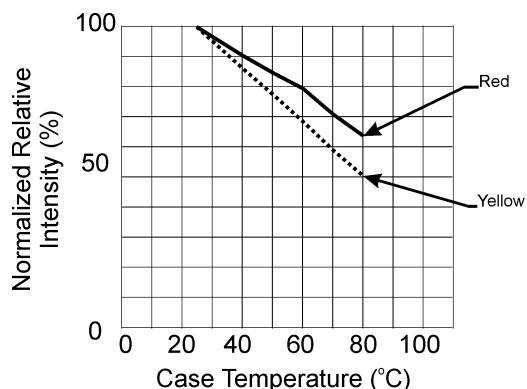
COMMON ANODE
MAN5X50



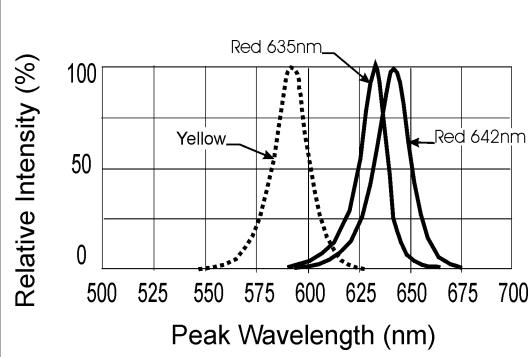
COMMON CATHODE
MAN5X60

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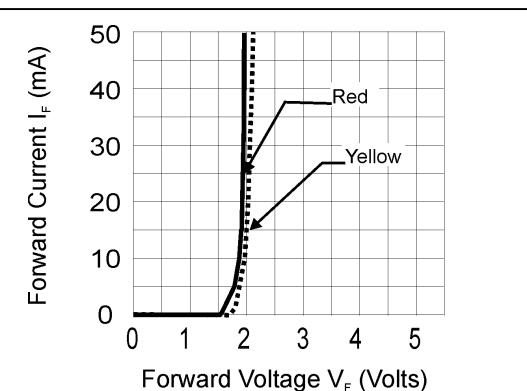
GRAPHICAL DATA AlInGaP ($T_A = 25^\circ\text{C}$, unless otherwise specified)



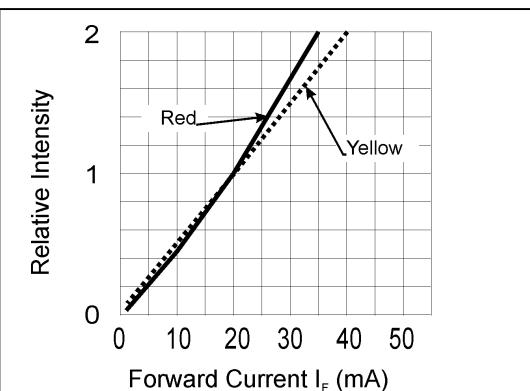
Relative Intensity vs Case Temp.



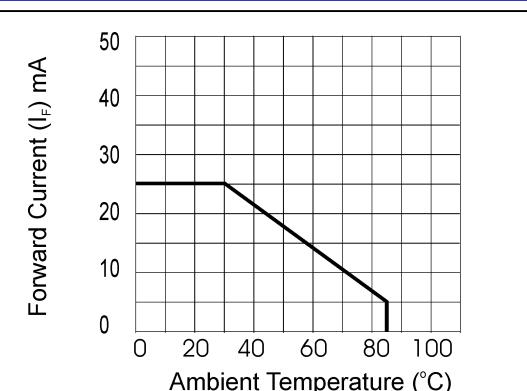
Spectral Response



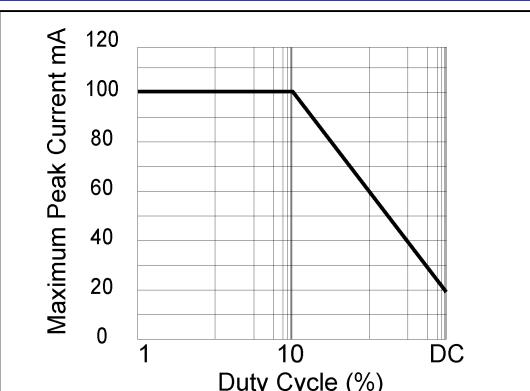
Forward Current vs Forward Voltage



Luminous Intensity vs Forward Current



Maximum Forward Current vs Ambient Temperature



Maximum Peak Current vs Duty Cycle



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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.